

Power Inductor

Automotive Grade

AWVF Series



Overview

Power inductors are passive electronic components used in various circuits to store energy in a magnetic field when electrical current flows through them. They are critical in filtering, energy storage, and noise suppression in power electronic systems.

They are designed to handle higher currents and are optimized for minimal power loss and thermal efficiency.

Benefits

1. Automotive grade available
2. No thermal aging
3. High current and efficiency, Magnetic epoxy sealing(Seme-shield)

Applications

1. Automotive Systems for Infotainment, MCU, Dashboard, CCD Module
2. Media player, Audio class
3. Net working, LCD Panel/TV,
4. Base stations, 5G infrastructure, and signal processing systems.
5. Telematics

Product Information

Series	L (mm)	W(mm)	T (mm)	Inductance (μH)
AWVF	2.0	1.6	1.2	0.24 ~ 330
	2.5	2.0	1.02	
	2.5	2.0	1.2	
	3.0	3.0	1.02	
	3.0	3.0	1.2	
	3.0	3.0	1.5	
	3.0	3.0	1.5	
	4.0	4.0	1.2	
	4.0	4.0	1.5	
	4.0	4.0	1.9	
	4.0	4.0	2.6	
	5.0	5.0	2.0	
	6.0	6.0	2.0	
	6.0	6.0	2.8	
	8.0	8.0	3.7~4.2	

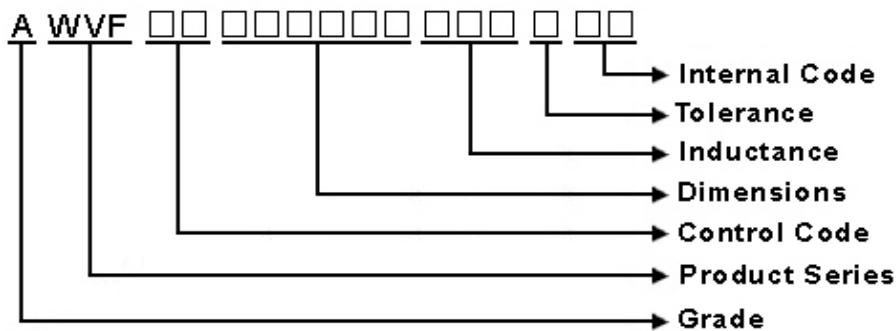


AWVF00252012 Series Specification

AEC-Q200

1 Scope: This specification applies to Wire Wound Power Inductors

2 Part Numbering:



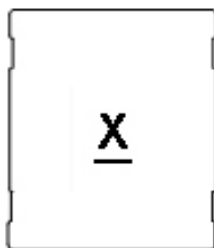
3 Rating:

Operating Temperature: - 4 0 °C ~ 1 2 5 °C(Including self - temperature rise)

Storage Temperature: - 4 0 °C ~ 1 2 5 °C

(The storage temperature range is for after the assembly)

4 Marking:



Ex Marking : C

Marking color : Black

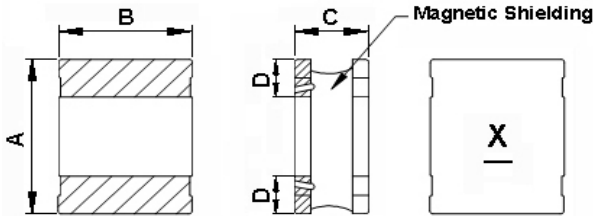
5 Standard Testing Condition

	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°C)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH

AWVF00252012 Series Specification

AEC-Q200

6 Configuration and Dimensions:



Dimensions in mm

TYPE	252012
A	2.5±0.25
B	2.0±0.25
C	1.2±0.05
D	0.8 typ.

Net Weight (grams)

SIZE CODE	Net Weight (grams)
252012	0.0296 (typ.)

7 Electrical Characteristics:

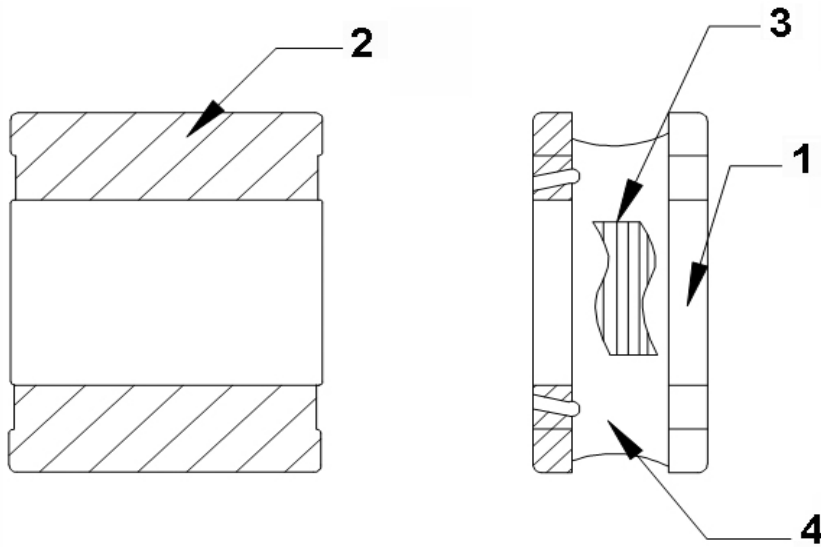
Part No.	Inductance (uH)	Test Freq.	RDC (Ω)±30%	Isat(mA) Typ.(Max)	Irms(mA) Typ.(Max)	Tolerance (±%)	Marking
AWVF00252012R50□00	0.5	1MHz,200mV	0.028	3500(3100)	3000(2700)	20,30	B
AWVF002520121R0□00	1.0	1MHz,200mV	0.05	2500(2200)	2400(2100)	20,30	C
AWVF002520121R2□00	1.2	1MHz,200mV	0.053	2100(1800)	2350(2100)	20,30	D
AWVF002520121R5□00	1.5	1MHz,200mV	0.068	1950(1700)	2300(2000)	20,30	E
AWVF002520122R2□00	2.2	1MHz,200mV	0.08	1800(1600)	1800(1600)	20,30	F
AWVF002520123R3□00	3.3	1MHz,200mV	0.13	1450(1200)	1500(1300)	20,30	G
AWVF002520124R7□00	4.7	1MHz,200mV	0.19	1100(980)	1100(980)	20,30	H
AWVF002520125R6□00	5.6	1MHz,200mV	0.21	1050(930)	1000(890)	20,30	I
AWVF002520126R8□00	6.8	1MHz,200mV	0.3	950(840)	800(710)	20,30	J
AWVF00252012100□00	10	1MHz,200mV	0.385	880(780)	700(620)	20,30	K
AWVF00252012150□00	15	1MHz,200mV	0.57	680(600)	620(540)	20,30	L
AWVF00252012220□00	22	1MHz,200mV	0.81	550(480)	530(460)	20,30	M

NOTE: □-tolerance M=±20% / T=±30%

1. Operating temperature range - 4 0°C ~ 1 2 5°C(Including self - temperature rise)
2. Isat for Inductance drop 30% from its value without current.
3. I rms for a 40°C temperature rise from 25°C ambient.

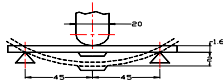
8 AWVF00252012 Series

8.1 Construction:



8.2 Material List:

No	Part	Material
1	Core	Ferrite
2	Terminal	Ag/Cu/Ni/Sn
3	Wire	Grade 180
4	Epoxy	Magnetic powder resin

9 Reliability of Wire Wound Power Inductors			
1-1.Mechanical Performance			
	Item	Specification	Test Method
1-1-1	Board Flex	The forces applied on the right conditions must not damage the terminal electrode and the ferrite.	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 60 sec 
1-1-2	Terminal Strength	The chip must not damage the terminal electrode and the ferrite.	Appendix 1 Note(AEC-Q200-005):Force of 1.8 kg for 60 seconds.
1-1-3	Solderability	The electrodes shall be at least 95% covered with new solder coating.	Pre-heating: 150℃, 1min Solder Composition: Sn/3.0Ag/0.5Cu Solder Temperature: 245±5℃ Immersion Time: 4±1sec
1-1-4	Resistance to Soldering Heat	Appearance:No damage Inductance change shall be within ±10%.	Pre-heating: 150℃, 1min Solder Composition: Sn/Ag3.0/Cu0.5 Solder Temperature: 260±5℃ Immersion Time: 10±1sec
1-1-5	Resistance to Solvents	There must be no change in appearance or obliteration of marking.	Inductors must withstand 6 minutes of alcohol or water.
1-1-6	Mechanical Shock	The forces applied on the right conditions must not damage the terminal electrode and the ferrite.	Pulse shape : Half-sine waveform Impact acceleration : 100 g Pulse duration : 6 ms Number of shocks : 18 shocks (3 shocks for each face) Orientation : Bottom, top, left, right, front and rear faces
1-1-7	Vibration	Appearance:No damage Inductance change shall be within ±10%.	Vibration waveform: Sine waveform Vibration frequency: 10Hz~2000Hz Vibration acceleration: 5g Sweep rate: 0.764386octave/minute Duration of test: 12 cycles each of 3 orientations 20 minutes for each cycle Vibration axes: X, Y & Z
1-2.Environmental Performance			
No	Item	Specification	Test Method
1-2-1	High Temperature Exposure (Storage)	Appearance:No damage (for microscope of CASTOR MZ-4 20X) Inductance change shall be within ±10%.	Temperature: 125±3℃ Time: 1000hrs Measured after exposure in the room condition for 24hrs
1-2-2	Operational Life		Temperature: 125±2℃ Applied Current : Rated Current Time: 1000± 24 hrs Measured after exposure in the room condition for 24hrs
1-2-3	Biased Humidity		Temperature: 85±2℃ Relative Humidity: 85% Time: 1000hrs Measured after exposure in the room condition for 24hrs
1-2-4	Temperature Cycling		Total cycles: 1000 cycles Temperature Cycling Test Conditions : -40 to +125 ℃ Soak Mode Condition : 30 minutes Measured after exposure in the room condition for 24hrs
1-2-5	ESD		Test mode : Contact Discharge Discharge level : ±6KV, Discharge interval : 1 second Polarity of the output voltage : Positive and negative Number of discharge : Discharge +/- for 1 time for the 2 test points. Test Mode : Air Discharge Discharge level : ±12KV, ±16KV, ±25KV Discharge interval : < 5 seconds Polarity of the output voltage : Positive and negative Number of discharge : Discharge +/- for 1 time for the 1~2 test points.



Lead-Free(LF)標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升温區 Ramp-up	預熱區 Pre-heating	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T ~ 150°C	150°C ~ 200°C	Above 217°C	260±5°C	Peak Temp.~150°C
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result	-	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	-

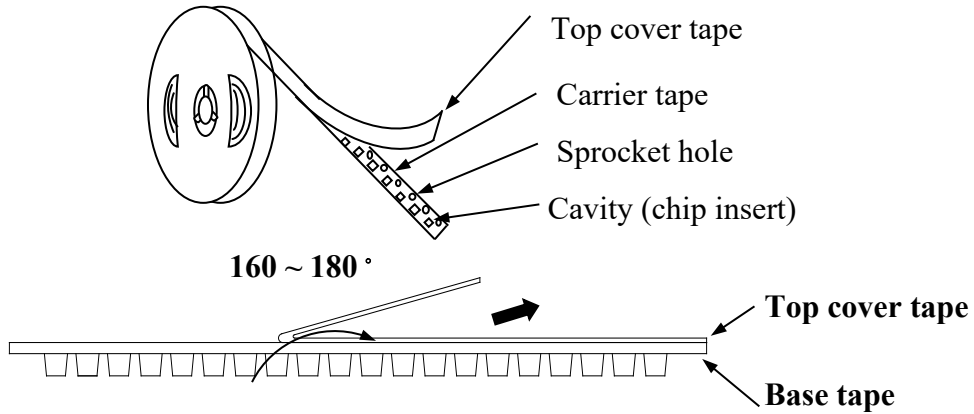
NOTE :

1. Re-flow possible times : within 2 times
2. Nitrogen adopted is recommended while in re-flow
3. Products can only be soldered with reflow

10 Packaging:

10.1 Packaging -Cover tape

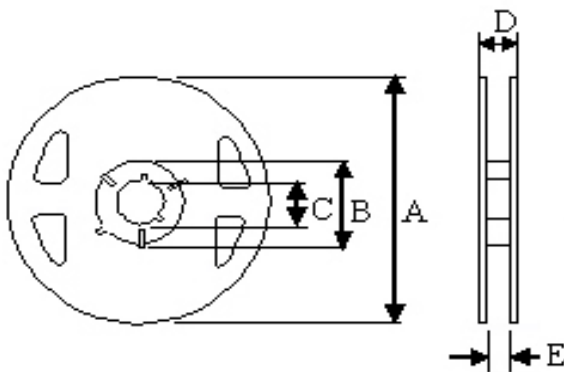
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

TYPE	PCS/REEL
252012	2000

10.3 Reel Dimensions

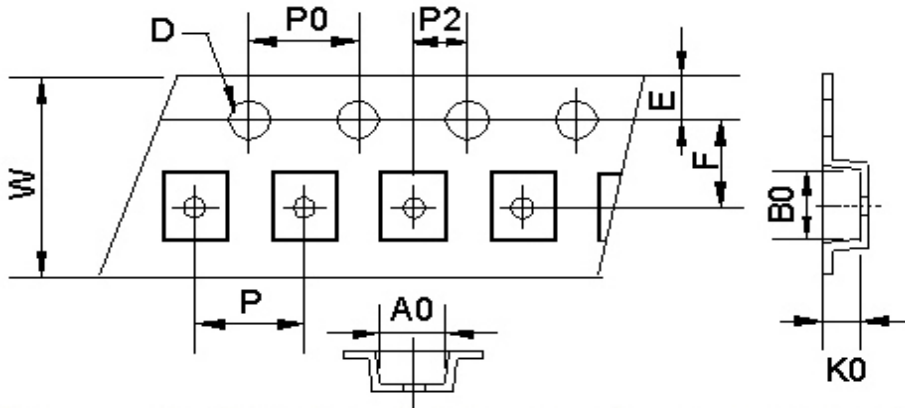


Dimensions in mm

TYPE	A	B	C	D	E
252012	180	60	13	14.4	8.4

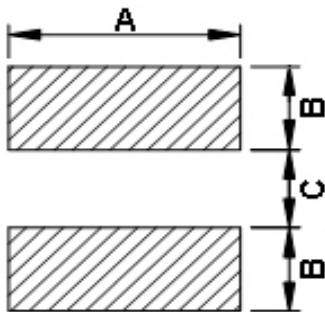
10 Packaging:

10.4 Tape Dimensions in mm



TYPE	A0	B0	K0	D	E	F	W	P	P0	P2
252012	2.4	2.75	1.35	1.55	1.75	3.5	8	4	4	2

11 Recommended Land Pattern:



Dimensions in mm

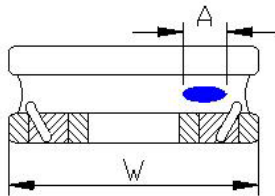
TYPE	A	B	C
252012	2.2	0.85	0.8

12 Note:

1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
2. Do not knock nor drop.
3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
4. The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
5. Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
6. The moisture sensitivity level (MSL) of products is classified as level 1.

12 Note:

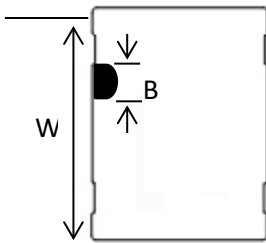
7. Void Appearance tolerance Limit



Exposed wire tolerance limit of coating resin part on product side.
The unilateral should be no more than two holes.

$$A \leq W/2 \text{ GOOD}$$

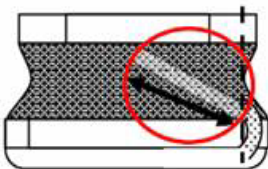
$$A > W/2 \text{ NG}$$



The appearance standard of the chipping size in top side.

$$B \leq W/5 \text{ GOOD}$$

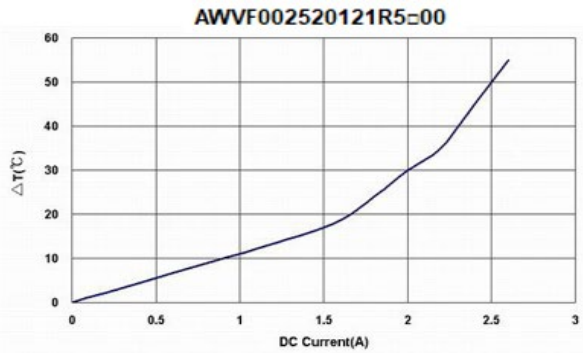
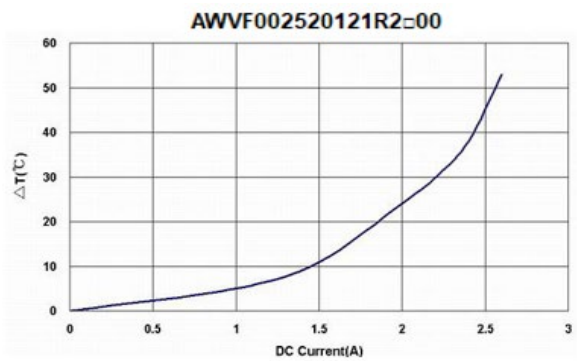
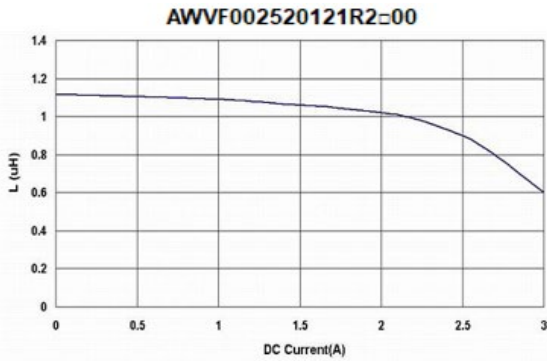
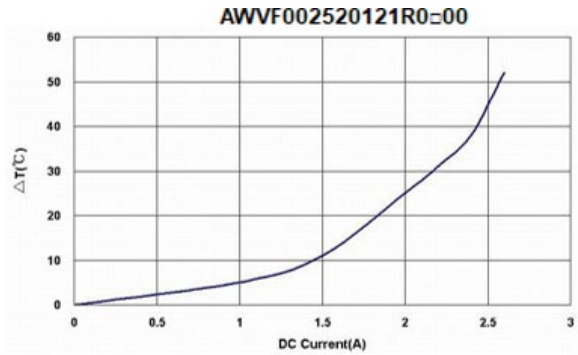
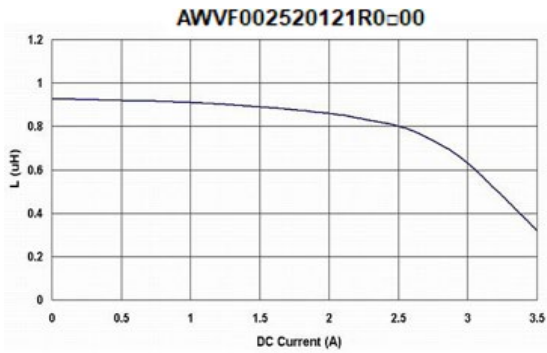
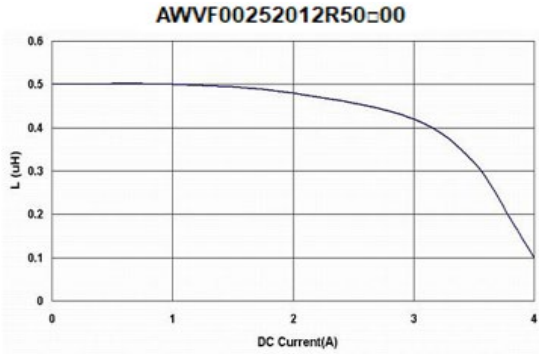
$$B > W/5 \text{ NG}$$



External appearance criterion for exposed wire

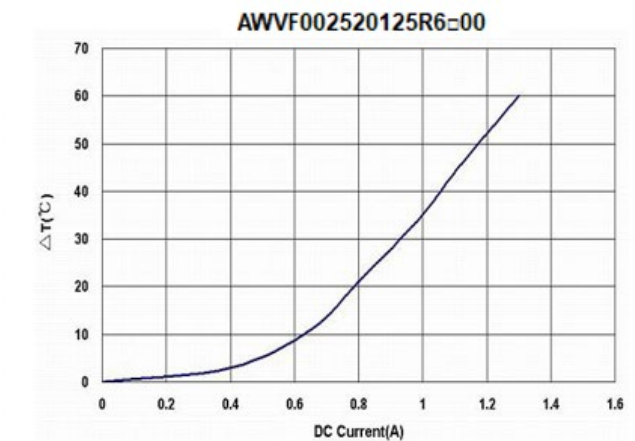
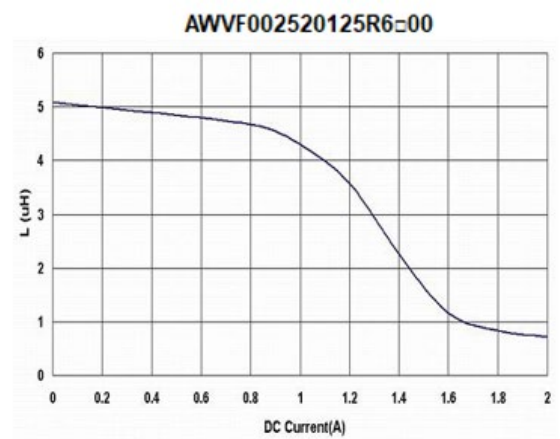
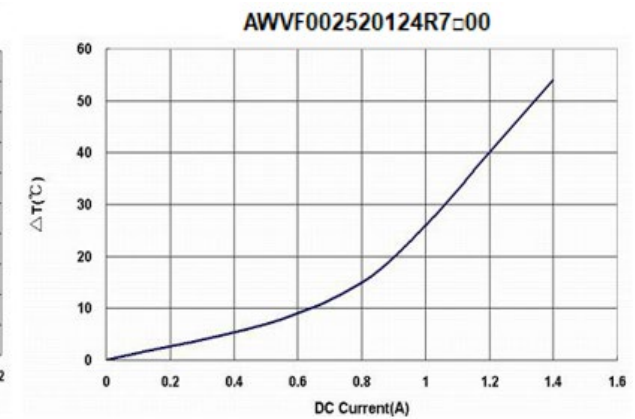
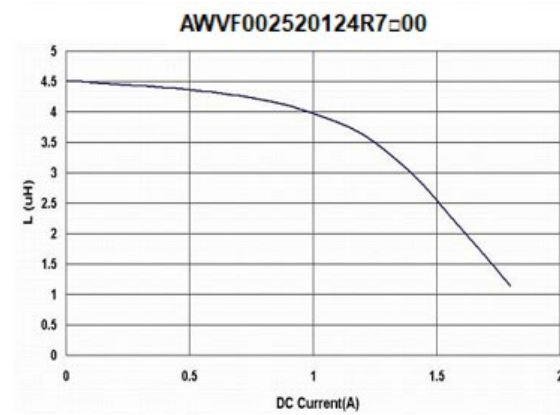
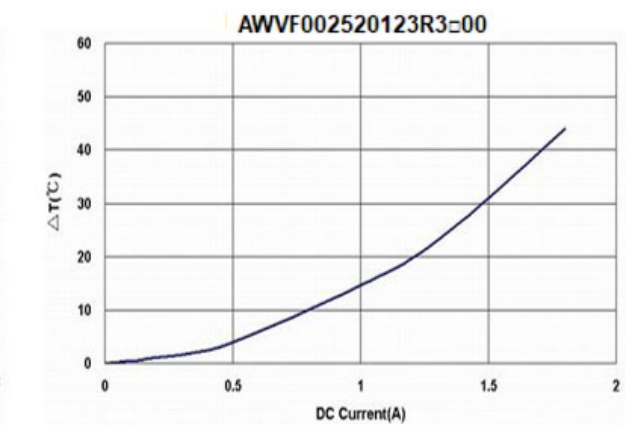
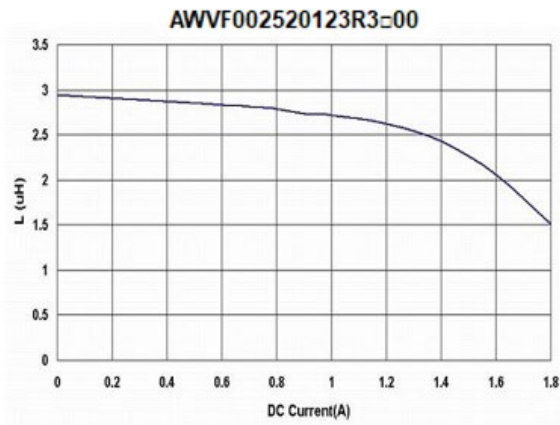
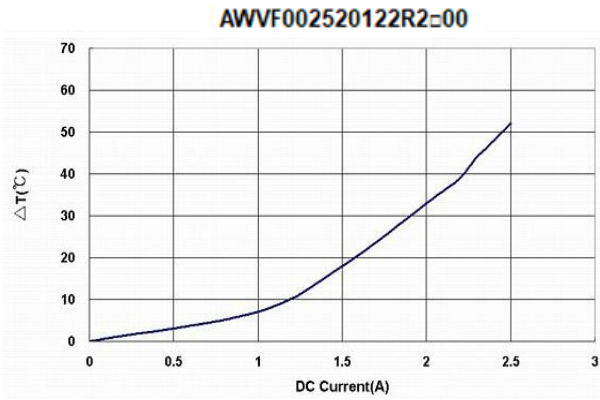
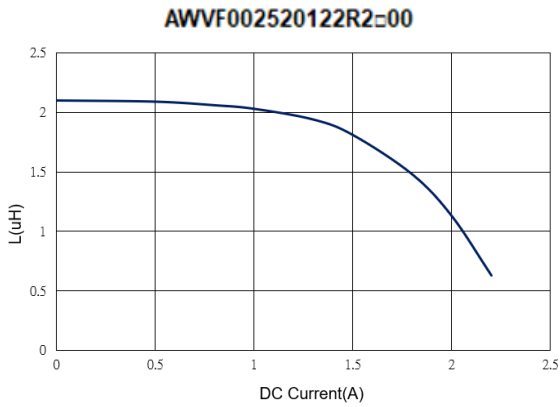
Exposed end of the winding wire at the side should be acceptable.

13 Graph: AWVF00252012 Series Graph

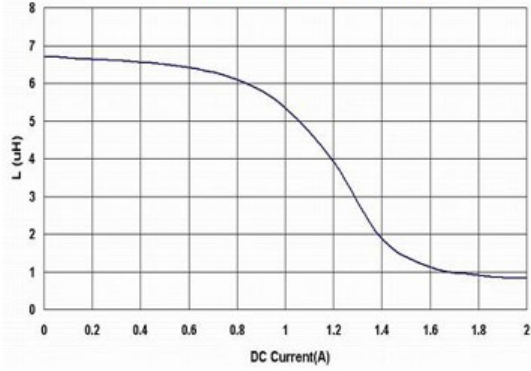


AWVF00252012 Series Specification

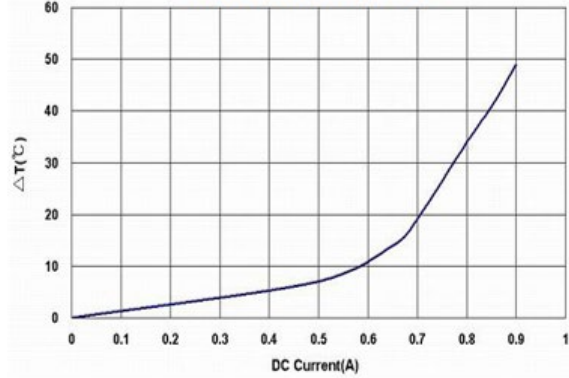
AEC-Q200



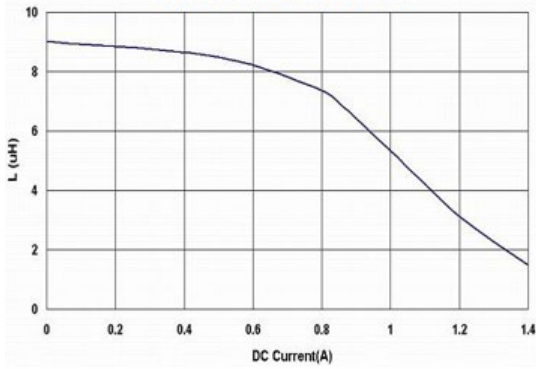
AWVF002520126R8=00



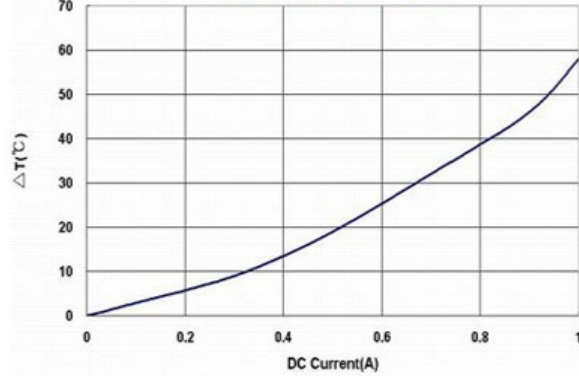
AWVF002520126R8=00



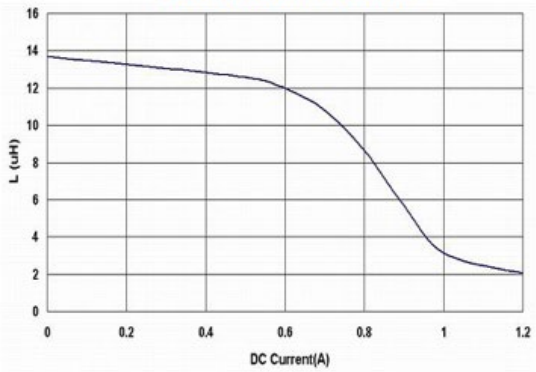
AWVF00252012100=00



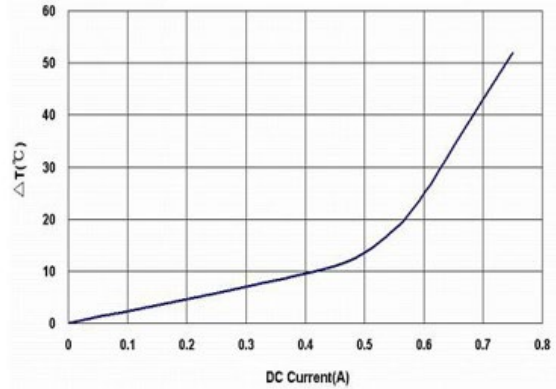
AWVF00252012100=00



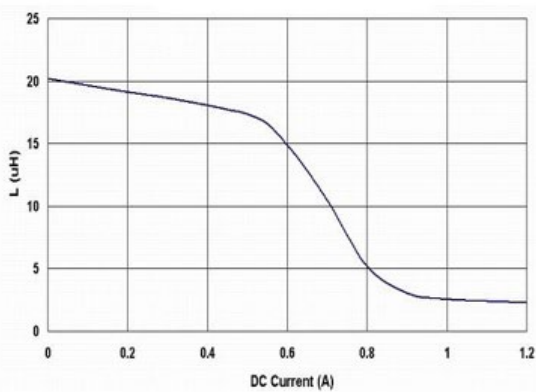
AWVF00252012150=00



AWVF00252012150=00



AWVF00252012220=00



AWVF00252012220=00

